

Day One- Monday, June 8, 2026

7:00 AM - 8:00 AM	Exhibitor Displays Setup
8:00 AM - 8:45 AM	Registration and Exhibitor
8:00 AM - 8:45 AM	Continental Breakfast
8:45 AM - 9:15 AM	Welcome and Opening Dr. Steven L. Johnson , President & CEO, Sinclair College J.P. Nauseef , President & CEO, JobsOhio
9:15 AM - 10:15 AM	Keynote Panel Topic: TBD Speakers: HQ AFMC
10:15 AM - 10:30 AM	Break
10:30 AM - 11:45 AM	Breakout Sessions Breakout 1: Recognition of an Integrated Defense Digital Ecosystem (Siemens) Breakout 2: Integrating Augmented Reality in UAS and AAM Maintenance Technician Training (Sinclair College and Northland Technical Community College) Breakout 3: Topic TBD (Southwest Research Institute)
11:45 AM - 12:45 PM	Lunch and Exhibition/Networking Opportunity
12:45 PM - 1:45 PM	Keynote Topic: Micro-electronics within Digital Engineering and Advanced Manufacturing Speaker: Tim Grayson, Ph.D., Former Special Assistant to the Secretary of the Air Force
1:45 PM - 3:00 PM	Breakout Sessions Breakout 1: Topic TBD (Ampex)

Breakout 2: From Scanning to Visualization: Understanding the Implementations of Highly Accessible and Enhanced 3D-Models (REscan 360)

Breakout 3: Readyng the Future Workforce: Implementing Digital-Based Programs and Degrees (Sinclair College, Lorain County Community College, Clark State Community College, Ohio University)

3:00 PM - 3:15 PM

Closing Remarks

3:15 PM - 5:00 PM

Reception in the Exhibitor Hall

*Food and first drink provided through sponsored ticket

*Opportunity to network and engage with exhibitors

Day Two- Tuesday, June 9, 2026

8:00 AM - 9:00 AM

Continental Breakfast

9:00 AM - 9:15 AM

Welcome and Opening

9:15 AM - 10:00 AM

Keynote:

Topic: TBD

Speaker: Lt. General (Ret.) Shaun Morris, USAF

10:00 AM - 10:15 AM

Break

10:15 AM - 11:30 AM

Breakout Sessions

Breakout 1: Understanding the Need for Digital Readiness for Autonomous Air Mobility (National Advanced Air Mobility Center of Excellence, ANRA, Connecticut Center of Advanced Technology)

Breakout 2: Applying PLM Across the Product Lifecycle: From Research to Sustainment (University of Dayton Research Institute)

Breakout 3: Cybersecurity for embedded systems (BAE Systems)

11:30 AM - 12:30 PM

Lunch and Exhibition/Networking Opportunity

12:30 PM - 1:30 PM

Keynote:

Topic: TBD

Speaker: Mr. Rodney Stevens, Program Executive Officer,
Training Directorate at AFLCMC

1:30 PM - 2:45 PM

Breakout Sessions

Breakout 1: Beyond Retrieval: Accelerating Acquisition
Workflows by Leveraging Network Visualizations (Mile Two)

Breakout 2: Scaling Digital Innovation Through Workforce
Ready Drone and Data Platforms (Critical Ops, Vets to Drones,
Lighthouse Avionics)

Breakout 3: Modeling and Software Perspective for Composable
Systems (Galois)

2:45 PM - 3:00 PM

Closing Remarks

3:00 PM - 4:00 PM

Travel to Digital Transformation Center Social

1520 S Main St Suite 214, Dayton, OH 45409

4:00 PM - 7:00 PM

Digital Transformation Center Social

*Food and drink provided by DTC

Day Three- Wednesday (June 10, 2026)

8:00 AM - 9:00 AM

Continental Breakfast

9:00 AM - 9:15 AM

Welcome and Opening

9:15 AM - 10:00 AM

Keynote

Topic: Preparing a Future-Ready IT/OT Cybersecurity Workforce

Speaker: Prof. John Sands (Moraine Valley Community College)

10:00 AM - 10:15 AM

Break

10:15 AM - 11:30 AM

Breakout Sessions

	Breakout 1: Topic TBD (STC Arcfield) Breakout 2: Implications of Artificial Intelligence for Educators Workshop (National Cybersecurity Training & Education Center) Breakout 3: Topic TBD (OnMain)
11:30 AM - 12:45 PM	Lunch and Exhibition/Networking Opportunity
12:45 PM - 1:45 PM	Keynote: TBD
1:45 PM - 3:00 PM	Breakout Sessions Breakout 1: Revolutionizing Product Design: AI-Driven Engineering for Development in Half the Time (McKinsey) Breakout 2: Interactive UAF-Based Enterprise Architecture: From Live Modeling to Actionable Analytics (MTSI) Breakout 3: Topic TBD (SkyGrid) Breakout 4: Dayton Defense Digital Roundtable
3:00 PM - 4:00 PM	Closing Remarks/Exhibitor Networking Time

**Current as of: February 24, 2026*